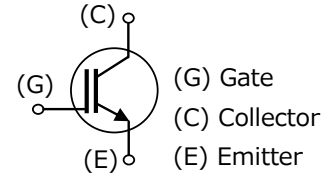




# MMJ6525B00\*\*



### Outline

IGBT (Bare chip) utilizes various technologies that we cultivated by analog semiconductor device production and is the product which prepared a lineup of the wide high voltage, high current which can contribute to high efficiency and saving energy.

### Applications

- Industrial Motor Drivers
- Inverter
- Welding
- UPS

### Features

- ① Field Stop Trench gate IGBT
- ② Low Collector-Emitter saturation voltage
- ③ High short circuit capability
- ④ Low switching losses

### Absolute Maximum Ratings

T<sub>j</sub>=25deg unless otherwise noted.

| Parameter                 | Symbol            | Rating   | Unit |
|---------------------------|-------------------|----------|------|
| Collector-Emitter voltage | V <sub>CE</sub> S | 650      | V    |
| Gate-Emitter voltage      | V <sub>GE</sub> S | ±30      | V    |
| Collector current *1)     | I <sub>C</sub>    | 25       | A    |
| Junction temperature      | T <sub>j</sub>    | -40~+150 | °C   |

\*1)Collector current is limited by T<sub>j</sub>(max) and thermal properties of assembly.

### Die Specification

| Item                          | Value            | Unit |
|-------------------------------|------------------|------|
| Die thickness                 | 86               | μm   |
| Die size                      | 3.38x3.38(11.42) | mm   |
| Front metal(AlSi)             | 6.5              | μm   |
| Backside metal(AlSi/Ti/Ni/Au) | 1.25             | μm   |

### Electrical Characteristics

T<sub>j</sub>=25deg unless otherwise noted.

| Parameter                                    | Symbol                | Specification |     |      | Unit | condition   |
|--|-----------------------|---------------|-----|------|------|---|
|  |                       | Min           | Typ | Max  |      |   |
| Zero gate voltage collector current          | I <sub>CE</sub> S     | -             | -   | 1    | μA   | V <sub>ce</sub> =650V, V <sub>ge</sub> =0V  |
| Gate-Emitter leakage current                 | I <sub>GE</sub> S     | -             | -   | ±100 | nA   | V <sub>ge</sub> =±30V, V <sub>ce</sub> =0V  |
| Gate-emitter threshold voltage               | V <sub>GE</sub> (th)  | 4.0           | -   | 6.0  | V    | V <sub>ce</sub> =10V, I <sub>c</sub> =0.8mA   |
| Collector-Emitter saturation voltage         | V <sub>CE</sub> (sat) | -             | 1.6 | 1.9  | V    | I <sub>c</sub> =25A, V <sub>ge</sub> =15V   |
| Input capacitance                            | C <sub>ies</sub>      | -             | 960 | -    | pF   | V <sub>CE</sub> =25V, V <sub>GE</sub> =0V, f=100kHz   |
| Reverse transfer capacitance                 | C <sub>res</sub>      | -             | 48  | -    | pF   |   |
| Switching time<br>*Reference characteristics | t <sub>d</sub> (on)   | -             | 50  | -    | ns   | V <sub>cc</sub> =330V, I <sub>c</sub> =25A<br>V <sub>GE</sub> =15/0V, T <sub>j</sub> =150°C<br>R <sub>g</sub> (on/off)=15Ω/41Ω,<br>Inductive load |
|  | t <sub>r</sub>        | -             | 45  | -    | ns   |   |
|  | t <sub>d</sub> (off)  | -             | 300 | -    | ns   |   |
|  | t <sub>f</sub>        | -             | 100 | -    | ns   |   |
| Short circuit withstand time                 | T <sub>sc</sub>       | 5             | -   | -    | μs   | V <sub>cc</sub> =400V, V <sub>ge</sub> =15V, T <sub>j</sub> =150°C  |

This characteristic is when it is incorporated in a mold package or evaluation board.

Depending on the assembly conditions etc., it may not be satisfied. Please note that it is not a guaranteed value.

### Die Dimension

